

## Please note that Cypress is an Infineon Technologies Company.

The document following this cover page is marked as "Cypress" document as this is the company that originally developed the product. Please note that Infineon will continue to offer the product to new and existing customers as part of the Infineon product portfolio.

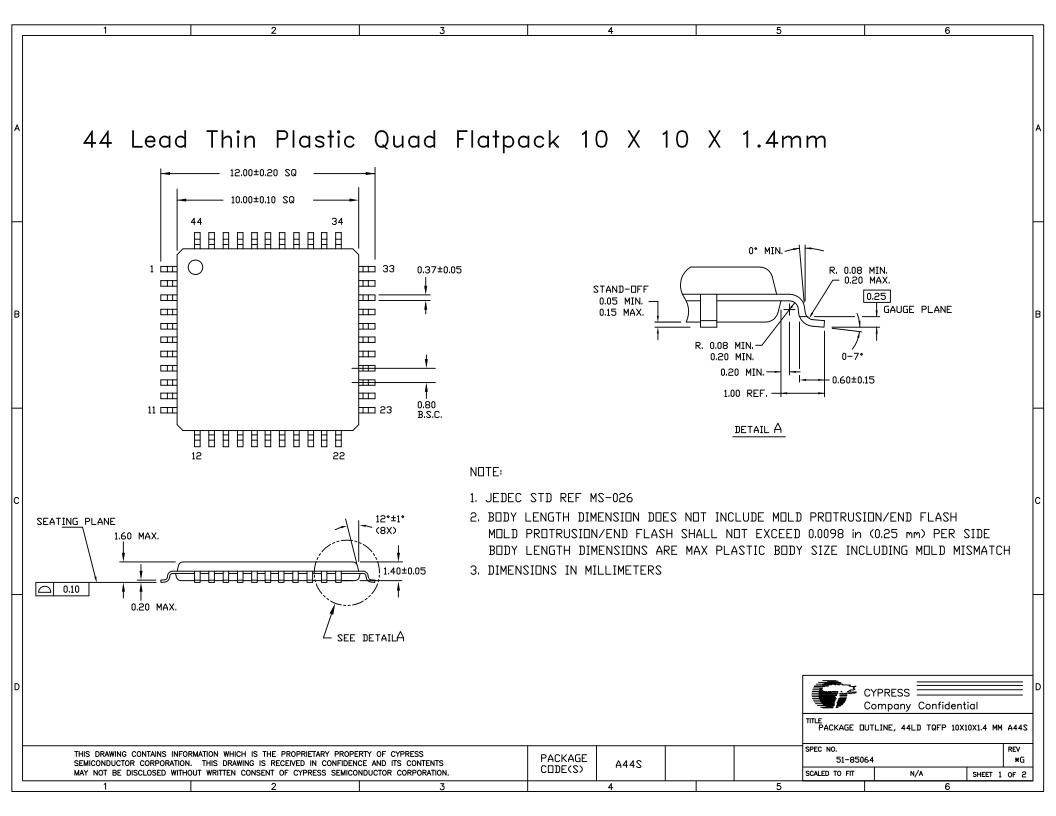
## **Continuity of document content**

The fact that Infineon offers the following product as part of the Infineon product portfolio does not lead to any changes to this document. Future revisions will occur when appropriate, and any changes will be set out on the document history page.

## **Continuity of ordering part numbers**

Infineon continues to support existing part numbers. Please continue to use the ordering part numbers listed in the datasheet for ordering.

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1			2	3		4		5			6	
				-								
Rev.	ECN No.	Origin of Change		Description of Ch	ange							
**	1108		NEW RELEASE									
*A	1545		ADD TOLERANCE ON	DIM.								
*B	49412		CHANGE TITLE									
*C	412838			REFERENCE MS-026 PROTRUSION/END FLASH INFORMATION								
*D	2835671			title from 44LD TQFP (10 X 10 X 1.4) F	PKG OUTLINE to P	ACKAGE OUTLINE,	44LD TQFP 10X1	0X1.4 MM A44S				
*E	3146096		ECN SUNSET NO CHA	NGE								
*F	4257091	KTQAD/ XANC	SUNSET REVIEW. CHA	NGED DRAWING TEMPLATE.								
*G	4991833	XANC	Changed terminal tol	erance from $\pm 0.25$ to $\pm 0.20$ .								
	1	1										
									C C		Confidential	4 MM A443
MICONDUCTOR	CORPORATION. TI	HIS DRAWING IS	IE PROPRIETARY PROPER RECEIVED IN CONFIDENC T OF CYPRESS SEMICON	E AND ITS CONTENTS	PACKAGE CDDE(S)	A44S			SPEC NO. 51-85064 SCALED TO FIT	1 N/A	cue	REV *G
1 2 310												_, _ Ur C